Onsemi

Ultrafast Diode 200 V, 20 A FFB20UP20S

Description

The FFB20UP20S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applications as welder application.

Features

- Ultrafast Recovery, $t_{rr} = 45 \text{ ns}$ (@ $I_F = 20 \text{ A}$)
- Max Forward Voltage, $V_F = 1.15 \text{ V} (@ T_C = 25^{\circ}\text{C})$
- Reverse Voltage, V_{RRM} = 200 V
- Avalanche Energy Rated
- RoHS Compliant

Applications

- Output Rectifiers
- SMPS, Welder, UPS
- Free–Wheeling Diode for Motor Application
- Power Switching Circuits

ABSOLUTE MAXIMUM RATINGS

 $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Rating	Unit	
V _{RRM}	Peak Repetitive Reverse Voltage	200	V	
V _{RWM}	Working Peak Reverse Voltage	200	V	
V _R	DC Blocking Voltage	200	V	
I _{F(AV)}	Average Rectified Forward Current @ $T_{C} = 115^{\circ}C$	20	A	
I _{FSM}	Non-repetitive Peak Surge Current 60 Hz Single Half-Sine Wave		A	
T _J , T _{STG}	Operating Junction and Storage Temperature Range	–65 to +175	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







F20UP20S = Specific Device Code А

- = Assembly Location
- Υ = Year
- WW = Work Week
- G = Pb-Free Package

FFB20UP20S

THERMAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction-to-Case	2.0	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFB20UP20STM	F20UP20S	D ² PAK	Reel	13″ Dia	N/A	800

ELECTRICAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Parameter	Conditions			Тур	Max	Unit
V _F (Note 1)	Forward Voltage $I_F = 20 A$ $I_F = 20 A$	$T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	-	-	1.15 1.0	V
I _R (Note 1)	Reverse Current V _R = 200 V V _R = 200 V	$T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	-		100 500	μΑ
t _{rr}	$ I_F = 1 \text{ A, } di_F/dt = 100 \text{ A}/\mu \text{s, } \text{V}_R = 30 \text{ V} \\ I_F = 20 \text{ A, } di_F/dt = 200 \text{ A}/\mu \text{s, } \text{V}_R = 130 \text{ V} $	$T_{C} = 25^{\circ}C$	-	-	35 45	ns
t _a t _b Q _{rr}	I_F = 20 A, di _F /dt = 200 A/µs, V _R = 130 V	$T_{C} = 25^{\circ}C$		11 13 21		ns ns nC
W _{AVL}	Avalanche Energy (L = 40 mH)		20	_	-	mJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle = 2%

Test Circuit and Waveforms



Figure 1. Diode Reverse Recovery Test Circuit & Waveform





FFB20UP20S

TYPICAL CHARACTERISTICS



Figure 3. Typical Forward Voltage Drop



Figure 4. Typical Reverse Current



Figure 5. Typical Junction Capacitance



Figure 7. Typical Reverse Recovery Current



Figure 6. Typical Reverse Recovery Time



Figure 8. Forward Current Derating Curve

FFB20UP20S

PACKAGE DIMENSIONS

D²PAK-3 (TO-263, 3-LEAD) CASE 418AJ

ISSUE F



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